# RENESAS

2Mb Advanced LPSRAM (256k word x 8bit)

R10DS0272EJ0101 Rev.1.01 2020.2.20

## Description

The R1LV0208BSA is a family of low voltage 2-Mbit static RAMs organized as 262,144-word by 8-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LV0208BSA has realized higher density, higher performance and low power consumption. The R1LV0208BSA is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. The R1LV0208BSA has been packaged in 32-pin sTSOP.

## Features

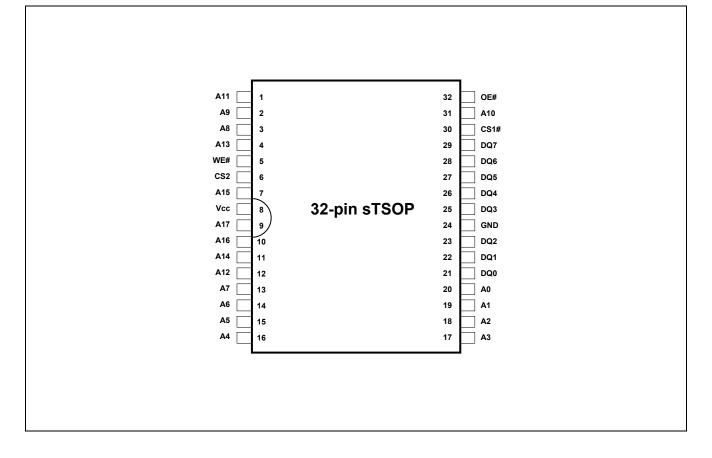
- Single 2.7V~3.6V power supply
- Small stand-by current: 1µA (3.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS1# and CS2
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus

## **Ordering Information**

Orderable part name	Access time	Temperature range	Package	Shipping container
R1LV0208BSA-5SI#B1	55	40	8mm×13.4mm 32-pin	Tray
R1LV0208BSA-5SI#S1	55 ns	-40 ~ +85°C	plastic sTSOP	Embossed tape



## **Pin Arrangement**

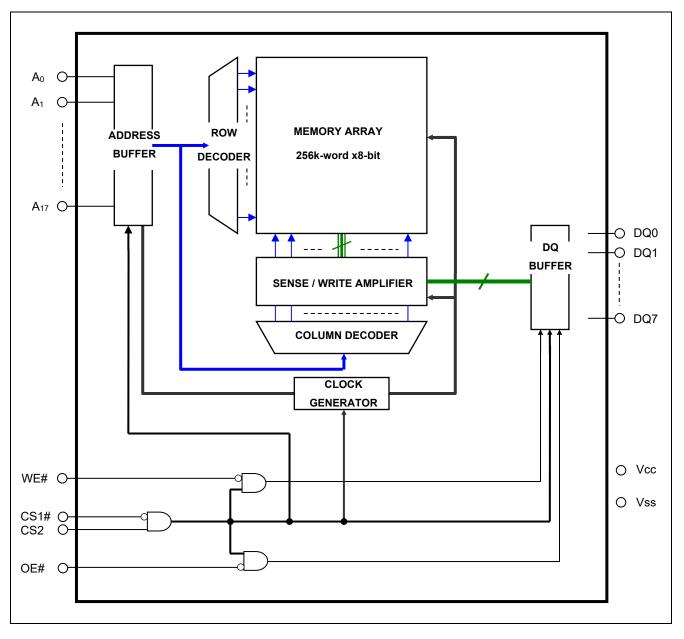


## **Pin Description**

Pin name	Function	
Vcc	Power supply	
Vss (GND)	Ground	
A0 to A17	Address input	
DQ0 to DQ7	Data input/output	
CS1#	Chip select 1	
CS2	Chip select 2	
WE#	Write enable	
OE#	Output enable	



## **Block Diagram**





## **Operation Table**

CS1#	CS2	WE#	OE#	DQ0~7	Operation
Х	L	Х	Х	High-Z	Stand-by
Н	Х	Х	Х	High-Z	Stand-by
L	Н	L	Х	Din	Write
L	Н	Н	L	Dout	Read
L	Н	Н	Н	High-Z	Output disable

Note 1. H: V\_{IH} L:V\_{IL} X: V\_{IH} or V\_{IL}

## **Absolute Maximum**

Parameter	Symbol	Value	unit
Power supply voltage relative to Vss	Vcc	-0.5 to +4.6	V
Terminal voltage on any pin relative to Vss	VT	-0.5 <sup>*1</sup> to Vcc+0.5 <sup>*2</sup>	V
Power dissipation	Ρτ	0.7	W
Operation temperature	Topr	-40 to +85	°C
Storage temperature range	Tstg	-65 to 150	°C
Storage temperature range under bias	Tbias	-40 to +85	°C

Note 1. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

2. Maximum voltage is +4.6V.



## **DC Operating Conditions**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	2.7	3.0	3.6	V	
	Vss	0	0	0	V	
Input high voltage	VIH	2.0	-	Vcc+0.3	V	
Input low voltage	VIL	-0.3	-	0.6	V	1
Ambient temperature range	Та	-40	-	+85	°C	

Note 1. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

## **DC Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions			
Input leakage current	ப	-	-	1	μA	Vin = Vss to Vcc			
Output leakage current	Ilo	-	-	1	μA	CS1# =V <sub>IH</sub> or CS2 =V <sub>IL</sub> or OE# =V <sub>IH</sub> , VI/O =Vss to Vcc			
Average operating current	Icc1	-	15	25	mA		duty =100%, II/O = 0mA, , CS2 =VIH, Others = VIH/VIL		
	Icc2	-	2	5	mA	Cycle =1 $\mu$ s, duty =100%, II/O = 0mA, CS1# ≤ 0.2V, CS2 ≥ Vcc-0.2V, V <sub>IH</sub> ≥ Vcc-0.2V, V <sub>IL</sub> ≤ 0.2V			
Standby current	Isb	-	-	0.33	mA		VIH, Others =VIH/VIL or /IL, Others =VIH/VIL		
Standby current		-	1 <sup>*1</sup>	2	μA	~+25°C	Vin = Vss to Vcc,		
	ISB1	-	-	3	μΑ	~+40°C	(1) CS2 ≤ 0.2V or (2) CS1# ≥ Vcc-0.2V,		
		-	-	8	μA	~+70°C	CS2 ≥ Vcc-0.2V		
		-	-	10	μA	~+85°C			
Output high voltage	V <sub>OH</sub>	2.4	-	-	V	I <sub>OH</sub> = -0.5mA			
	V <sub>OH2</sub>	Vcc - 0.5	-	-	V	I <sub>OH</sub> = -0.05mA			
Output low voltage	V <sub>OL</sub>	-	-	0.4	V	I <sub>OL</sub> = 2mA			

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

## Capacitance

	(Vcc = 2.7V ~ 3.6V, f = 1MHz, Ta = -40 ~ +85°C						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	8	pF	Vin =0V	1
Input / output capacitance	<b>C</b> 1/O	-	-	10	pF	VI/O =0V	1

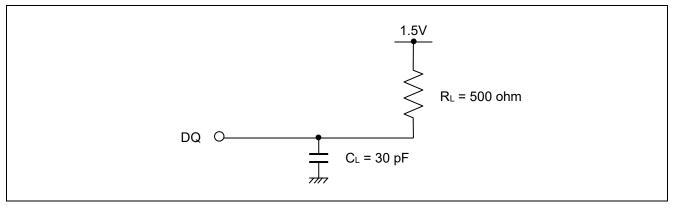
Note 1. This parameter is sampled and not 100% tested.



## **AC Characteristics**

Test Conditions (Vcc =  $2.7V \sim 3.6V$ , Ta =  $-40 \sim +85^{\circ}C$ )

- Input pulse levels: VIL = 0.4V, VIH = 2.2V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)



#### **Read Cycle**

Parameter	Symbol	Min.	Max.	Unit	Note
Read cycle time	t <sub>RC</sub>	55	-	ns	
Address access time	taa	-	55	ns	
Chin colort copped time	t <sub>ACS1</sub>	-	55	ns	
Chip select access time	t <sub>ACS2</sub>	-	55	ns	
Output enable to output valid	toe	-	30	ns	
Output hold from address change	toн	10	-	ns	
Chin colort to output in low 7	t <sub>CLZ1</sub>	10	-	ns	2,3
Chip select to output in low-Z	t <sub>CLZ2</sub>	10	-	ns	2,3
Output enable to output in low-Z	tolz	5	-	ns	2,3
Chin deceleration autout in high 7	t <sub>CHZ1</sub>	0	20	ns	1,2,3
Chip deselect to output in high-Z	t <sub>CHZ2</sub>	0	20	ns	1,2,3
Output disable to output in high-Z	tонz	0	20	ns	1,2,3

#### Write Cycle

Parameter	Symbol	Min.	Max.	Unit	Note
Write cycle time	twc	55	-	ns	
Address valid to end of write	t <sub>AW</sub>	50	-	ns	
Chip select to end of write	tcw	50	-	ns	5
Write pulse width	twp	45	-	ns	4
Address setup time	tas	0	-	ns	6
Write recovery time	twR	0	-	ns	7
Data to write time overlap	t <sub>DW</sub>	25	-	ns	
Data hold from write time	t <sub>DH</sub>	0	-	ns	
Output enable from end of write	tow	5	-	ns	2
Output disable to output in high-Z	tонz	0	20	ns	1,2
Write to output in high-Z	twнz	0	20	ns	1,2

Note 1. t<sub>CHZ</sub>, t<sub>OHZ</sub> and t<sub>WHZ</sub> are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition, t<sub>HZ</sub> max is less than t<sub>LZ</sub> min both for a given device and from device to device.

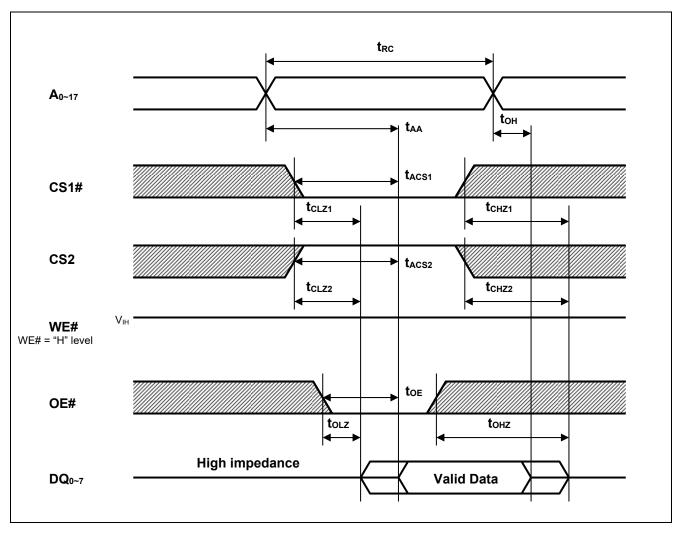
4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE#.
A write begins at the latest transition among CS1# going low, CS2 going high and WE# going low.
A write ends at the earliest transition among CS1# going high, CS2 going low and WE# going high.
t<sub>WP</sub> is measured from the beginning of write to the end of write.

- 5. t<sub>CW</sub> is measured from the later of CS1# going low or CS2 going high to end of write.
- 6. t<sub>AS</sub> is measured the address valid to the beginning of write.
- 7. twR is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.



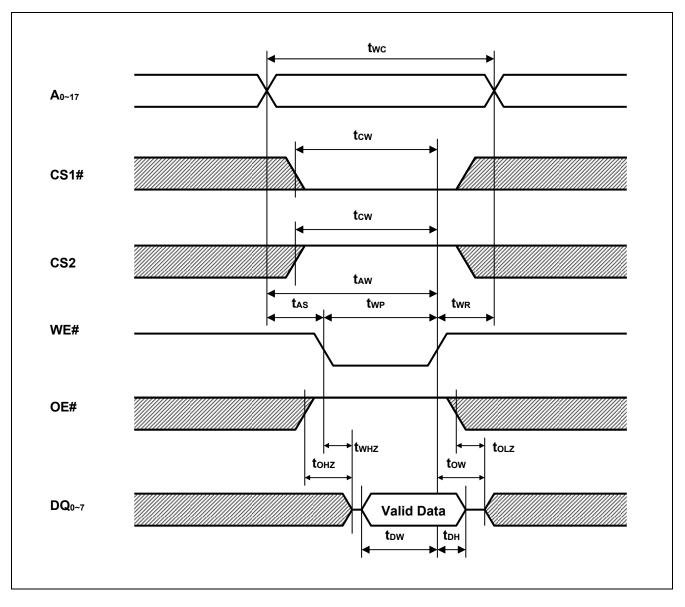
## **Timing Waveforms**

## Read Cycle



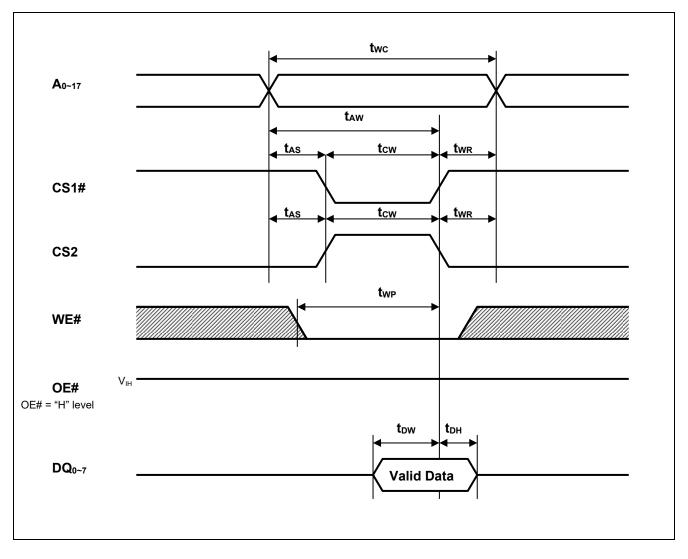


## Write Cycle (1) (WE# CLOCK)





## Write Cycle (2) (CS1#, CS2 CLOCK)





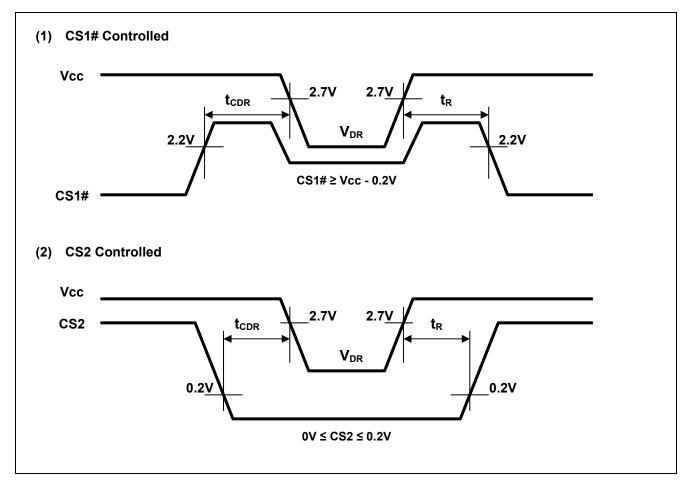
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions <sup>*2</sup>		
V <sub>CC</sub> for data retention	Vdr	2.0	-	3.6	V	Vin ≥ 0V, (1) $0V \le CS2 \le 0.2V$ or (2) $CS1\# \ge Vcc-0.2V$ , $CS2 \ge Vcc-0.2V$		
	Iccdr	-	1 <sup>*1</sup>	2	μA	~+25°C	Vcc=3.0V, Vin ≥ 0V,	
Dete schenfige somert		-	-	3	μA	~+40°C	(1) $0V \le CS2 \le 0.2V$ or	
Data retention current		-	-	8	μA	~+70°C	(2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μA	~+85°C		
Chip deselect time to data retention	t <sub>CDR</sub>	0	-	-	ns	Soo rotont	ion waveform	
Operation recovery time	t <sub>R</sub>	5	-	-	ms	See retention waveform.		

#### Low Vcc Data Retention Characteristics

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

CS2 controls address buffer, WE# buffer, CS1# buffer, OE# buffer and Din buffer. If CS2 controls data retention mode, Vin levels (address, WE#, CS1#, OE#, DQ) can be in the high impedance state.
 If CS1# controls data retention mode, CS2 must be CS2 ≥ Vcc-0.2V or 0V ≤ CS2 ≤ 0.2V. The other input levels (address, WE#, OE#, DQ) can be in the high impedance state.

#### Low Vcc Data Retention Timing Waveforms



<b>Revision History</b>
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## R1LV0208BSA Data Sheet

			Description			
Rev.	Date	Page	Summary			
1.00	2017.1.27	-	First Edition issued			
1.01	2020.2.20	Last page	Updated the Notice to the latest version			

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(Rev.1.0 Mar 2020)

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